

LVDS Interface ICs

35bit LVDS Transmitter 35:5 Serializer



BU8254GUW No.13057EBT10

Description

LVDS Interface IC of ROHM "Serializer" "Deserializer" operate from 8MHz to 150MHz wide clock range, and number of bits range is from 35 to 70. Data is transmitted seven times (7X) stream and reduce cable number by 3(1/3) or less. The ROHM's LVDS has low swing mode to be able to expect further low EMI.

Features

- 1) 35bits data of parallel LVCMOS level inputs are converted to five channels of LVDS data stream.
- 30bits of RGB data and 5bits of timing and control data(HSYNC,VSYNC,DE,CNTL1,CNTL2) are transmitted up to 784Mbps effective rate per LVDS channel.
- 3) Support clock frequency from 8MHz up to 112MHz.
- 4) Support consumer video format including 480i, 480P, 720P and 1080i as well.
- 5) Clock edge selectable
- 6) Power down mode
- 7) Support spread spectrum clock generator.
- 8) Support reduced swing LVDS for low EMI.
- 9) 30bit LVDS receiver is recommended to use BU90R104.

Applications

Flat Panel Display

Precaution

- ■This chip is not designed to protect from radioactivity.
- ■The chip is made strictly for the specific application or equipment. Then it is necessary that the unit is measured as need.
- ■This document may be used as strategic technical data which subjects to COCOM regulations.

Block Diagram

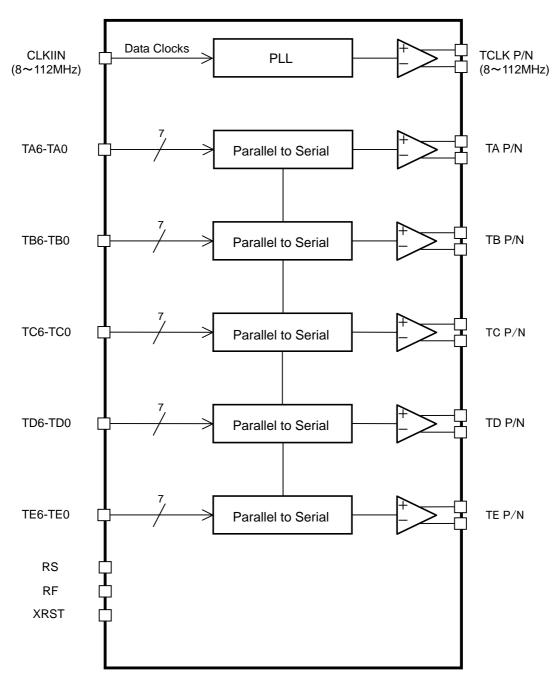


Fig.1 Block Diagram

●VBGA099W060 Package Outline and Specification

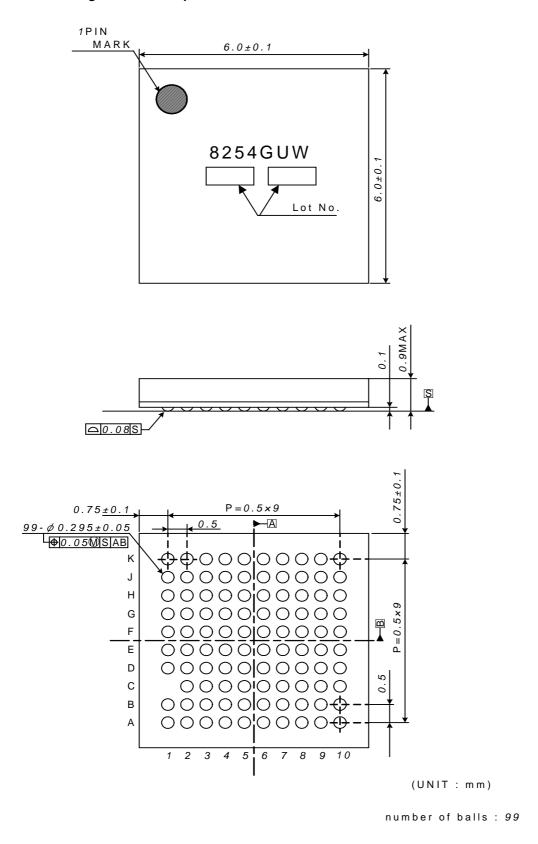


Fig.2 VBGA099W060 Package Outline and Specification

Technical Note

●Pin configuration

	1	2	3	4	5	6	7	8	9	10
Α	(NC)	TAN	TAP	ТВР	TCN	TCLKN	TDN	TEN	(NC)	(NC)
В	(NC)	(NC)	TBN	LVDSVDD	TCP	TCLKP	TDP	TEP	(NC)	(NC)
С	(1PIN)	(NC)	LVDSGND	LVDSGND	(NC)	(NC)	LVDSGND	(NC)	PLLVDD	PLLGND
D	TA5	TA1	TA0	TA2	(NC)	(NC)	TE6	(NC)	(NC)	(NC)
E	ТВ0	TA4	TA3	GND	TA6	(NC)	XRST	TE5	GND	CLK_IN
F	TB2	TB1	RS	ТВ3	(NC)	TE3	VDD	TE1	TE2	TE4
G	TB4	(NC)	GND	TB5	(NC)	(NC)	TE0	(NC)	GND	TD6
Н	(NC)	(NC)	(NC)	(NC)	TC4	(NC)	(NC)	(NC)	(NC)	TD5
J	(NC)	TB6	VDD	TC2	GND	TC6	RF	TD2	TD4	(NC)
К	(NC)	TC0	TC1	ТС3	TC5	TD0	TD1	TD3	(NC)	(NC)

Fig.3 Pin Diagram (Top View)

●Pin Description

Table 1 : Pin Description

Table 1 : Pin Desc	cription						
Pin Name	Pin No.	Туре	Descriptions				
TAP, TAN	A3,A2	LVDS OUT					
TBP, TBN	A4,B3	LVDS OUT					
TCP, TCN	B5,A5	LVDS OUT	LVDS data out.				
TDP, TDN	B7,A7	LVDS OUT					
TEP, TEN	B8,A8	LVDS OUT					
TCLKP, TCLKN	B6,A6	LVDS OUT		LVDS clock out.			
TA0~TA6	D3,D2,D4,E3,E2,D1,E5	IN					
TB0∼TB6	E1,F2,F1,F4,G1,G4,J2	IN					
TC0~TC6	K2,K3,J4,K4,H5,K5,J6	IN		Pixel data inputs.			
TD0~TD6	K6,K7,J8,K8,J9,H10,G10	IN					
TE0~TE6	G7,F8,F9,F6,F10,E8,D7	IN					
XRST	E7	IN	H : Normal operation, L : Power down (all outputs are Hi-Z)				
			LVDS swing mode, V _{REF} 1select.				
			RS	LVDS Swing	Small Swing Input Support		
RS	F3	IN	V_{DD}	350mV	N/A		
110			0.6~1.4V	350mV	RS-V _{REF}		
			GND	200mV	N/A		
			*1 V _{REF} is Input Reference Voltage.				
RF	J7	IN	Input clock triggerin H: Rising edge, L:				
VDD	F7,J3	Power	Power supply pins	for LVCMOS input	s and digital core.		
CLKIN	E10	IN	Clock input.				
GND	E4,E9,G3,G9,J5	Ground	Ground pins for LV	CMOS inputs and	digital core.		
LVDS VDD	B4	Power	Power supply pins for LVDS outputs.				
LVDS GND	C3,C4,C7	Ground	Ground pins for LVDS outputs.				
PLLVDD	C9	Power	Power supply pin for PLL core.				
PLLGND	C10	Ground	Ground pins for PLL core.				

Electrical characteristics

■ Rating

Table 2: Absolute Maximum Rating

Parameter	Symbol	Rat	ting	Units	
Faiametei	Symbol Min		Max	Office	
Supply Voltage	V_{DD}	-0.3	4.0	V	
Input Voltage	V _{IN}	-0.3	V _{DD} +0.3	V	
Output Voltage	V _{OUT}	-0.3	V _{DD} +0.3	V	
Storage Temperature Range	Tstg	-55	125	ပ	

Table 3: Package Power

PACKAGE	Power Dissipation (mW)	De-rating (mW/°C) *1
VDC 4 00014/000	380	3.8
VBGA099W060	880 ^{*2}	8.8 ^{*2}

At temperature Ta >25°C

Package power when mounting on the PCB board.

The size of PCB board :70×70×1.6(mm³)

The material of PCB board :The FR4 glass epoxy board.(3% or less copper foil area) (It is recommended to apply the above package power requirement to PCB board

when the small swing input mode is used)

Table 4: Recommended Operating Conditions

Parameter	Symbol		Rating		Units	Conditions	
Parameter	Symbol	Min	Тур	Max	Units	Conditions	
Supply Voltage	V_{DD}	3.0	3.3	3.6	V	VDD,LVDSVDD,PLLVDD	
Operating Temperature Range	Topr	-20	-	85	°C	Clock frequency from 8MHz up to 90MHz	
Operating remperature Kange	ΙΟΡΙ	0	-	70	°C	Cock frequency from 90MHz up to 112MHz	

■DC characteristics

Table 5 : LVCMOS DC Specifications(V_{DD}=3.0V~3.6V, Ta=-20°C~85°C)

Parameter	Symbol		Rating		Units	Conditions	
Parameter	Symbol	Min	Тур	Max	Units		
High Level Input Voltage	V _{IH}	$V_{DD} \times 0.8$	-	V_{DD}	V	exclude RS pin	
Low Level Input Voltage	V _{IL}	GND	-	V _{DD} × 0.2	V	exclude No pill	
High Level Input Voltage	V _{IHRS}	V _{DD} × 0.8	-	V_{DD}		RS pin	
Low Level Input Voltage	V _{ILRS}	GND	-	0.2		No pili	
Small Swing Voltage	V_{DDQ}^{*1}	1.2	-	2.8	V		
Input Reference Voltage	V_{REF}	-	$V_{DDQ}/2$	-	-	Small Swing(RS=V _{DDQ} /2)	
Small Swing High Level Input Voltage	V _{SH} ^{*2}	V _{DDQ} /2 +200mV	-	-	V	V _{REF} =V _{DDQ} /2	
Small Swing Low Level Input Voltage	V _{SL} *2	-	-	V _{DDQ} /2 -200mV	V	V _{REF} =V _{DDQ} /2	
Input Current	I _{INC}	-10	-	+10	μΑ	0V≤ V _{IN} ≤ V _{DD}	

^{*1:} V_{DDQ} voltage defines max voltage of small swing input. It is not an actual input voltage. *2: Small swing signal is applied to TA[6:0], TB[6:0], TC[6:0], TD[6:0] TE[6:0], CLKIN.

Table 6 : LVDS Transmitter DC Specifications($V_{DD}=3.0V\sim3.6V$, Ta=-20°C ~85 °C)

Parameter	Symbol	Symbol Rating			Units Co		nditions	
Falanietei	Symbol	Min	Min	Min	Units	Conditions		
Differential Output Voltage	V	250	350	450	mV	RL=100Ω	Normal swing RS=V _{DD}	
Differential Output Voltage	V_{OD}	100	200	300	mV	KL=10032	Reduced swing RS=GND	
Change in VOD between complementary output states	ΔV_{OD}	-	-	35	mV			
Common Mode Voltage	V _{OC}	1.125	1.25	1.375	V	RL=100Ω		
Change in VOC between complementary output states	ΔV _{OC}	-	-	35	mV			
Output Short Circuit Current	los	-	-	-24	mA	V_{OUT} =0 V , RL =100 Ω		
Output TRI-STATE Current	l _{OZ}	-10	-	+10	μA	XRST=0V, \	/ _{OUT} =0V to V _{DD}	

■Supply Current

Table 7 : Supply Current

Davamatav	Curahal	Rating			Llusita	0 100		
Parameter	Symbol	Min	Тур	Max	Units	Conditions		
Transmitter Supply Current		ı	57	ı	mA	RL=100 Ω ,CL=5pF V _{DD} =3.3V,RS=V _{DD} Gray Scale Pattern	f=85MHz	
	I _{TCCG}	-	42	-	mA	RL=100Ω,CL=5pF V _{DD} =3.3V,RS=GND Gray Scale Pattern	f=85MHz	
Transmitter Supply		-	62	-	mA	RL=100Ω,CL=5pF V _{DD} =3.3V,RS=V _{DD} Worst Case pattern	f=85MHz	
Current	Itccw	-	45	-	mA	RL=100Ω,CL=5pF V _{DD} =3.3V,RS=GND Worst Case pattern	f=85MHz	
Transmitter Power Down Supply Current	I _{TCCS}	-	-	10	μA	XRST=L		

Gray Scale Pattern

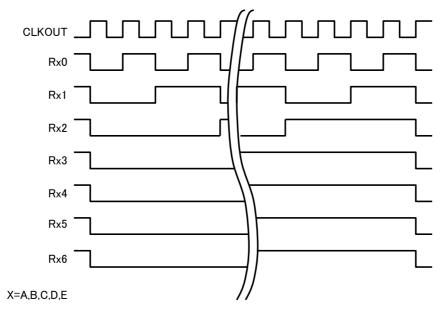


Fig.4 Gray scale pattern

Worst Case Pattern (Maximum Power condition)

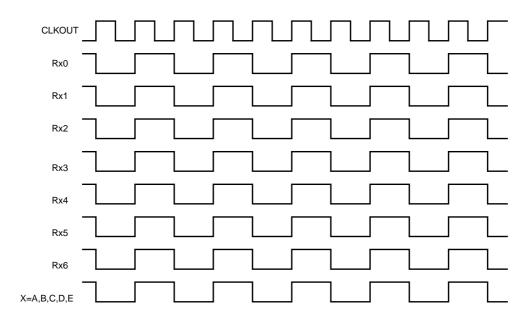


Fig.5 Worst Case Pattern

■AC characteristics

Table 8: Switching Characteristics

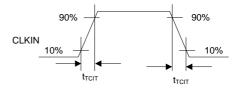
Table 8 : Switching Characteristics Parameter	Symbol	Min	Тур	Max	Units
CLK IN Transition time	t _{TCIT}	-	-	5.0	ns
CLK IN Period	t _{TCP}	8.93	-	125.0	ns
CLK IN High Time	t _{TCH}	0.35t _{TCP}	0.5t _{TCP}	0.65t _{TCP}	ns
CLK IN Low Time	t _{TCL}	0.35t _{TCP}	0.5t _{TCP}	0.65t _{TCP}	ns
CLK IN to TCLK+/-Delay	t _{TCD}	-	t _{TCP}	-	ns
LVSMOS Data Set up to CLK IN	t _{TS}	2.5	-	-	ns
LVCMOS Data Hold from CLK IN	t _{TH}	0	-	-	ns
LVDS Transition Time	t _{LVT}	-	0.6	1.5	ns
Output Data Position 0	t _{TOP1}	-0.2	0.0	+0.2	ns
Output Data Position 1	t _{TOP0}	$\frac{\text{tTCP}}{7}$ -0.2	<u>tTCP</u> 7	$\frac{\text{tTCP}}{7} + 0.2$	ns
Output Data Position 2	t _{TOP6}	$2\frac{\text{tTCP}}{7}$ -0.2	2 ttcp 7	$2\frac{\text{tTCP}}{7} + 0.2$	ns
Output Data Position 3	t _{TOP5}	$3\frac{\text{tTCP}}{7}$ -0.2	3 ttcp 7	$3\frac{\text{tTCP}}{7} + 0.2$	ns
Output Data Position 4	t _{TOP4}	$4\frac{\text{tTCP}}{7}$ -0.2	4 ttcp 7	$4\frac{\text{tTCP}}{7} + 0.2$	ns
Output Data Position 5	t _{TOP3}	$5\frac{\text{tTCP}}{7}$ -0.2	5 ttcp 7	$5\frac{\text{tTCP}}{7} + 0.2$	ns
Output Data Position 6	t _{TOP2}	$6\frac{\text{tTCP}}{7}$ -0.2	6 ttcp 7	$6\frac{\text{tTCP}}{7} + 0.2$	ns
Phase Locked Loop Set Time	t _{TPLL}	-	-	10.0	ms

Technical Note

AC Timing

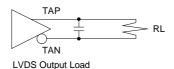
■AC Timing Diagrams

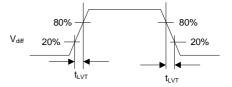
LVCMOS Input



LVCMOS Output

LVDS Output $V_{diff} = (TAP) - (TAN)$





LVCMOS Input

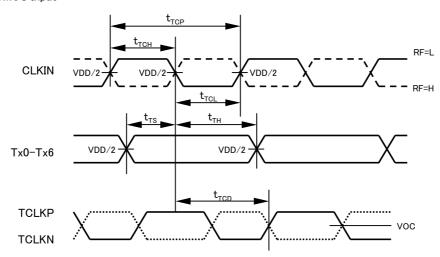


Fig.6 AC Timing Diagrams

■Small Swing Inputs

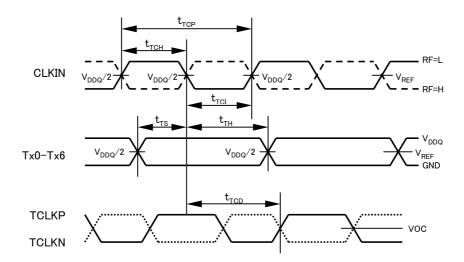


Fig.7 Small Swing Inputs

■AC Timing Diagrams

LVDS Output

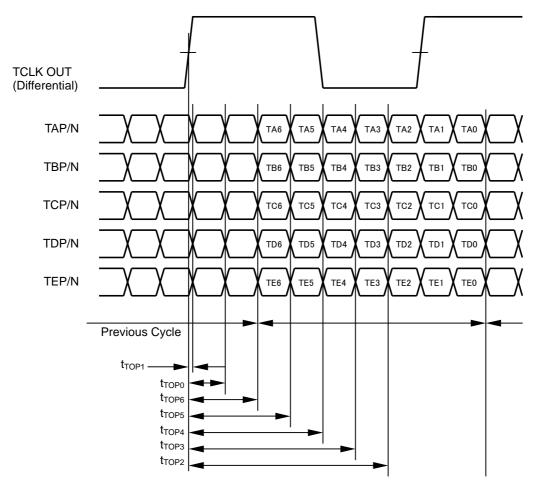


Fig.8 AC Timing Diagrams

■Phase Locked Loop Set Time

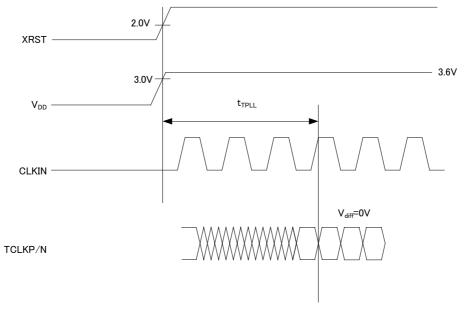


Fig.9 Phase Locked Loop Set Time

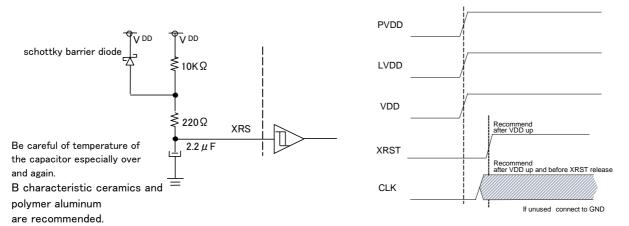
System Timing Requirement

System Timing Requirement is mandatory by following two methods.

- ①The method of using CR circuit.(In the case that CLK does not stop after power supply)
- ② The method of using external specific IC. (In the case that CLK turns on/off after power supply)

It is recommend to do enough examination for target application.

① The method of using CR circuit.(In the case that CLK does not stop after power supply)



td is apporoximately equal to 20ms when the left RC coleus applied

Fig.10 The method of using CR circuit

②The method of using external specific IC. (In the case that CLK turns on/off after power supply)

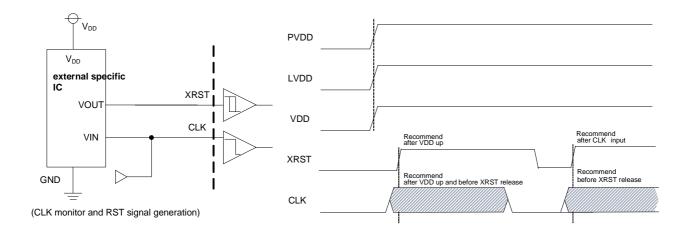


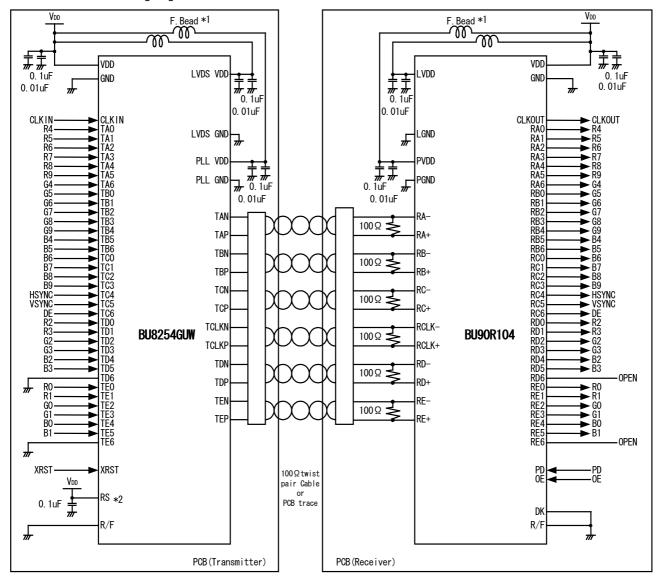
Fig.11 The method of using external specific IC.

●10bit LVCMOS Level Input

Example:

BU8254GUW : LVCMOS level input/Falling edge/Normal swing

BU90R104 : Falling edge



*1: Recommended Parts: F.Bead: BLM18A-Series (Murata Manufacturing)

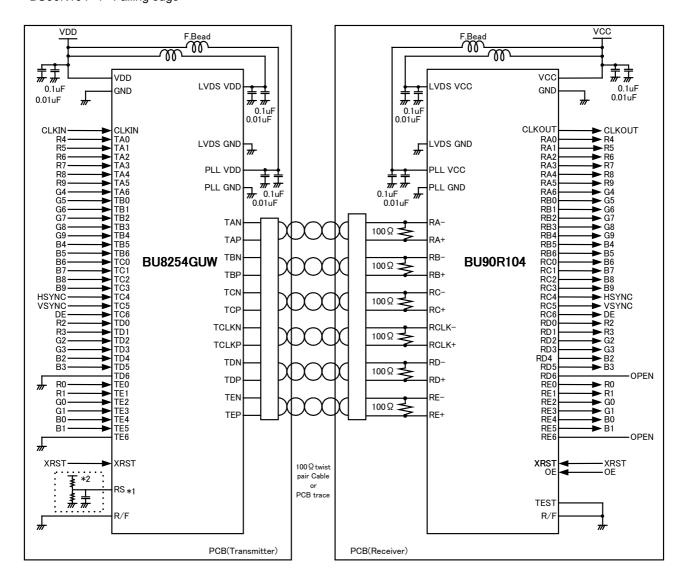
*2: If RS pin is tied to V_{DD}, LVDS swing is 350m V. If RS pin is tied to GND, LVDS swing is 200m V.

●10bit Small Swing Input

Example:

BU8254GUW : LVCMOS level input/Falling edge/Normal swing

BU90R104 : Falling edge



^{*3:} Recommended Parts:

F.Bead : BLM18A-Series (Murata Manufacturing)

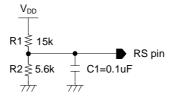
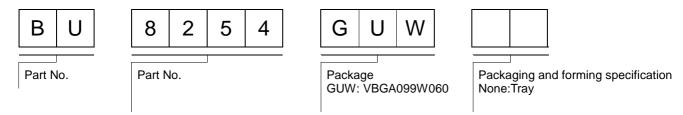


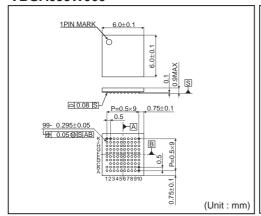
Fig.12 Example for LVCMOS(1.8V input)(R1,R2)=(1.5k Ω ,5.6k Ω)

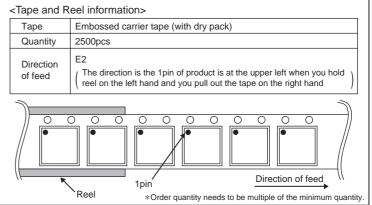
^{*4 :} RS pin acts as VREF input pin when input voltage is set to half of high level signal input. We recommend to locate by-pass condenser near the RS pin.

Ordering Part Number



VBGA099W060





Notice

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JAPAN	USA	EU	CHINA	
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSIII	
CLASSIV	CLASSIII	CLASSⅢ	CLASSIII	

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation (Pd) depending on Ambient temperature (Ta). When used in sealed area, confirm the actual ambient temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used; if flow soldering method is preferred, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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BU8254GUW - Web Page

Distribution Inventory

Part Number	BU8254GUW
Package	VBGA099W060
Unit Quantity	2000
Minimum Package Quantity	2000
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes